MC10EP89

3.3V / 5V ECL Coaxial Cable Driver

The MC10EP89 is a differential fanout gate specifically designed to drive coaxial cables. The device is especially useful in digital video broadcasting applications; for this application, since the system is polarity free, each output can be used as an independent driver. The driver produces swings 70% larger than a standard ECL output. When driving a coaxial cable, proper termination is required at both ends of the line to minimize signal loss. The 1.6 V (5 V) and 1.4 V (3.3 V) swing allow for termination at both ends of the cable, while maintaining a 800 mV (5 V) and 700 mV (3.3 V) swing at the receiving end of the cable. Because of the larger output swings, the device cannot be terminated into the standard V_{CC}–2.0 V. All of the DC parameters are tested with a 50 Ω to V_{CC}–3.0 V load. The driver accepts a standard differential ECL input and can run off of the digital video broadcast standard –5.0 V supply.

- 310 ps Typical Propagation Delay
- Maximum Frequency > 2 GHz Typical
- 1.6 V (5 V) and 1.4 V (3.3 V) V_{OUTpp} Swing
- PECL Mode Operating Range: V_{CC} = 3.0 V to 5.5 V with V_{EE} = 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = –3.0 V to –5.5 V
- Open Input Default State
- Safety Clamp on Inputs
- Q Output Will Default LOW with Inputs Open or at V_{EE}

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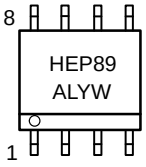
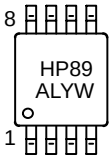
MARKING DIAGRAMS*

SO–8
D SUFFIX
CASE 751



TSSOP–8
DT SUFFIX
CASE 948R

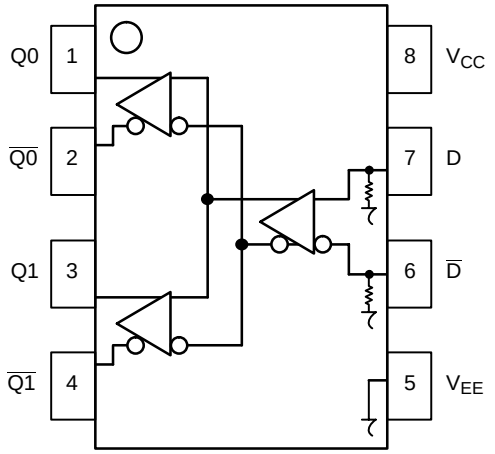


A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

*For additional information, see Application Note AND8002/D

ORDERING INFORMATION

Device	Package	Shipping
MC10EP89D	SO–8	98 Units/Rail
MC10EP89DR2	SO–8	2500 Tape & Reel
MC10EP89DT	TSSOP–8	100 Units/Rail
MC10EP89DTR2	TSSOP–8	2500 Tape & Reel



PIN DESCRIPTION

PIN	FUNCTION
D*, $\overline{D}$*	ECL Data Inputs
Q0, Q1, $\overline{Q0}$, $\overline{Q1}$	ECL Data Outputs
V_{CC}	Positive Supply
V_{EE}	Negative Supply

* Pins will default LOW when left open.

Figure 1. 8–Lead Pinout (Top View) **and Logic Diagram**

ATTRIBUTES

Characteristics		Value
Internal Input Pulldown Resistor		75 kΩ
Internal Input Pullup Resistor		N/A
ESD Protection	Human Body Model Machine Model Charged Device Model	> 4 kV > 200 V > 2 kV
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)		Level 1
Flammability Rating	Oxygen Index: 28 to 34	UL–94 V–0 @ 0.125 in
Transistor Count		152 Devices
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test		

1. For additional information, see Application Note AND8003/D.

MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V_{CC}	PECL Mode Power Supply	V_{EE} = 0 V		6	V
V_{EE}	NECL Mode Power Supply	V_{CC} = 0 V		–6	V
V_I	PECL Mode Input Voltage NECL Mode Input Voltage	V_{EE} = 0 V V_{CC} = 0 V	$V_I \leq V_{CC}$ $V_I \geq V_{EE}$	6 –6	V V
I_{out}	Output Current	Continuous Surge		50 100	mA mA
TA	Operating Temperature Range			–40 to +85	°C
T_{stg}	Storage Temperature Range			–65 to +150	°C
θ_{JA}	Thermal Resistance (Junction–to–Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction–to–Case)	std bd	8 SOIC	41 to 44	°C/W
θ_{JA}	Thermal Resistance (Junction–to–Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction–to–Case)	std bd	8 TSSOP	41 to 44	°C/W
T_{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

2. Maximum Ratings are those values beyond which device damage may occur.

DC CHARACTERISTICS, PECL V_{CC} = 3.3 V, V_{EE} = 0 V (Note 3)

		–40°C			25°C			85°C			
Symbol	**Characteristic**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**
IEE	Power Supply Current	22	28	34	24	32	38	28	34	40	mA
V_{OH}	Output HIGH Voltage (Note 4)	2080	2180	2280	2150	2250	2350	2225	2325	2425	mV
V_{OL}	Output LOW Voltage (Note 4)	620	720	820	630	730	830	670	770	870	mV
V_{IH}	Input HIGH Voltage (Single–Ended)	2070		2410	2170		2490	2240		2580	mV
V_{IL}	Input LOW Voltage (Single–Ended)	1350		1800	1350		1820	1350		1855	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 5)	2.0		3.3	2.0		3.3	2.0		3.3	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

3. Input and output parameters vary 1:1 with V_{CC}.
4. All loading with 50 Ω to V_{CC}–3.0 volts.
5. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

DC CHARACTERISTICS, PECL V_{CC} = 5.0 V, V_{EE} = 0 V (Note 6)

		–40°C			25°C			85°C			
Symbol	**Characteristic**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**
IEE	Power Supply Current	27	34	41	30	37	44	32	39	46	mA
V_{OH}	Output HIGH Voltage (Note 7)	3780	3880	3980	3850	3950	4050	3925	4025	4125	mV
V_{OL}	Output LOW Voltage (Note 7)	2075	2225	2375	2060	2210	2360	2090	2240	2390	mV
V_{IH}	Input HIGH Voltage (Single–Ended)	3770		4110	3870		4190	3940		4280	mV
V_{IL}	Input LOW Voltage (Single–Ended)	3050		3500	3050		3520	3050		3555	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 8)	2.0		5.0	2.0		5.0	2.0		5.0	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

6. Input and output parameters vary 1:1 with V_{CC}.
7. All loading with 50 Ω to V_{CC}–3.0 volts.
8. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

DC CHARACTERISTICS, NECL V_{CC} = 0 V, V_{EE} = –3.3 V (Note 9)

Symbol	Characteristic	–40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
IEE	Power Supply Current	22	28	34	24	32	38	28	34	40	mA
V_{OH}	Output HIGH Voltage (Note 10)	–1220	–1120	–1020	–1150	–1050	–950	–1075	–975	–875	mV
V_{OL}	Output LOW Voltage (Note 10)	–2680	–2580	–2480	–2670	–2570	–2470	–2630	–2530	–2430	mV
V_{IH}	Input HIGH Voltage (Single–Ended)	–1230		–890	–1130		–810	–1060		–720	mV
V_{IL}	Input LOW Voltage (Single–Ended)	–1950		–1500	–1950		–1480	–1950		–1445	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 11)	–1.3		0.0	–1.3		0.0	–1.3		0.0	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current D	0.5			0.5			0.5			μA

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

9. Input and output parameters vary 1:1 with V_{CC}.
10. All loading with 50 Ω to V_{CC}–3.0 volts.
11. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

DC CHARACTERISTICS, NECL V_{CC} = 0V, V_{EE} = –5.2 (Note 12)

Symbol	Characteristic	–40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
IEE	Power Supply Current	25	32	39	28	35	42	31	38	45	mA
V_{OH}	Output HIGH Voltage (Note 13)	–1220	–1120	–1020	–1150	–1050	–950	–1075	–975	–875	mV
V_{OL}	Output LOW Voltage (Note 13)	–2950	–2800	–2650	–2950	–2850	–2650	–2950	–2800	–2650	mV
V_{IH}	Input HIGH Voltage (Single–Ended)	–1230		–890	–1130		–810	–1060		–720	mV
V_{IL}	Input LOW Voltage (Single–Ended)	–1950		–1500	–1950		–1480	–1950		–1445	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 14)	–3.2		0.0	–3.2		0.0	–3.2		0.0	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

12. Input and output parameters vary 1:1 with V_{CC}.
13. All loading with 50 Ω to V_{CC}–3.0 volts.
14. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

AC CHARACTERISTICS V_{CC} = 0V; V_{EE} = –3.0 V to –5.5 V or V_{CC} = 3.0 V to 5.5 V; V_{EE} = 0 V (Note 15)

		–40°C			25°C			85°C			
Symbol	**Characteristic**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**
f_{max}	Maximum Toggle (See Figure 2 F_{max}/JITTER)		> 2			> 2			> 2		GHz
t_{PLH}, t_{PHL}	Propagation Delay to Output Differential	220	280	340	250	310	370	270	330	390	ps
t_{SKEW}	Within Device Skew Q, $\overline{Q}$ Device to Device Skew (Note 16)		5.0	20 120		5.0	20 120		5.0	20 120	ps
t_{JITTER}	Cycle–to–Cycle Jitter (See Figure 2 F_{max}/JITTER)		.5	< 1		.5	< 1		.5	< 1	ps
V_{PP}	Input Voltage Swing (Differential)	150	800	1200	150	800	1200	150	800	1200	mV
t_r t_f	Output Rise/Fall Times Q, $\overline{Q}$ (20% – 80%)	175	250	325	200	275	350	225	295	375	ps

15. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50 Ω to V_{CC}–3.0 V.
16. Skew is measured between outputs under identical transitions.

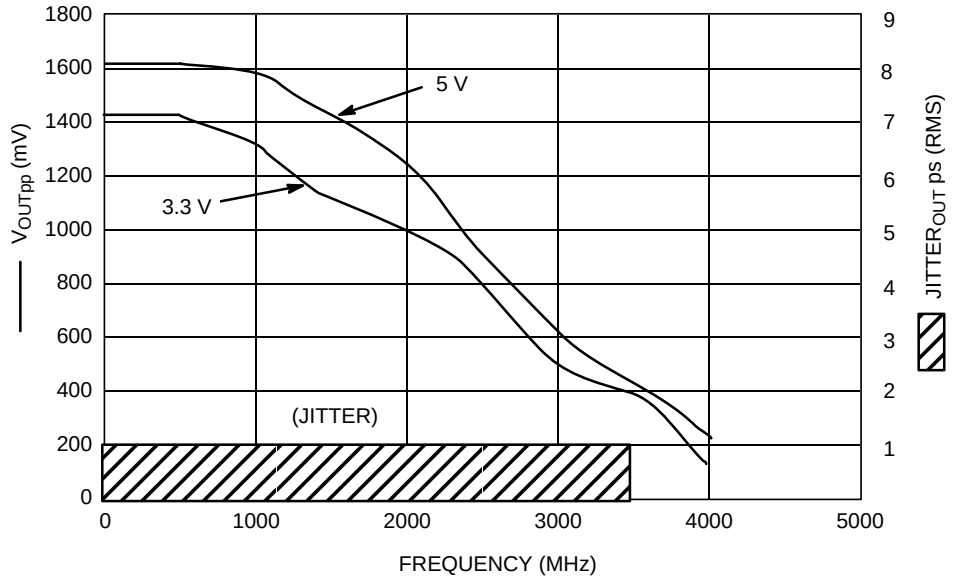
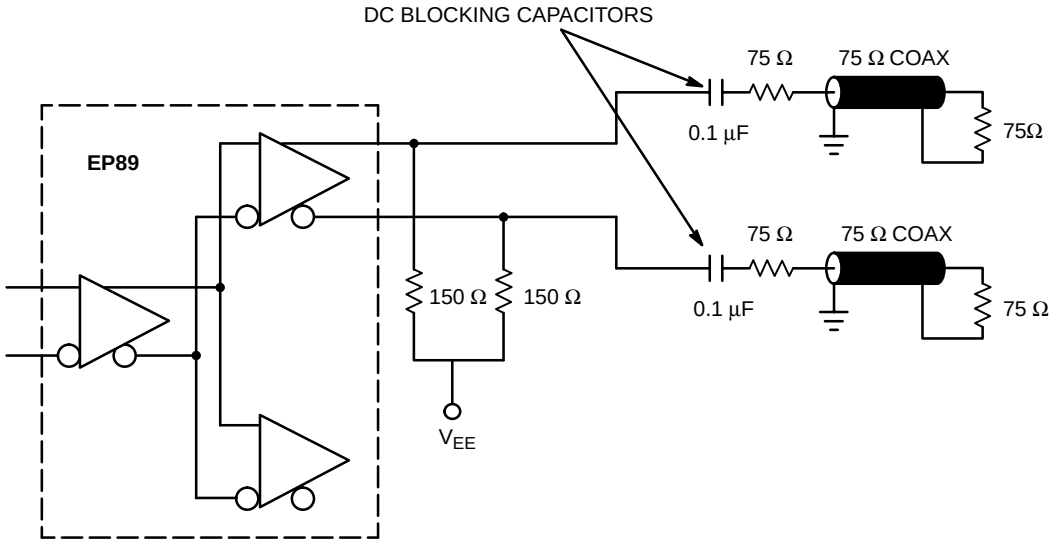
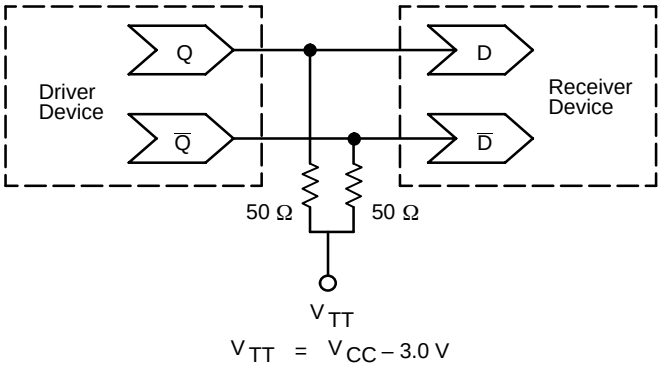


Figure 2. F_{max}/Jitter



Cable Driver Termination Configuration



Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 – Termination of ECL Logic Devices.)

Figure 3. Termination Configurations

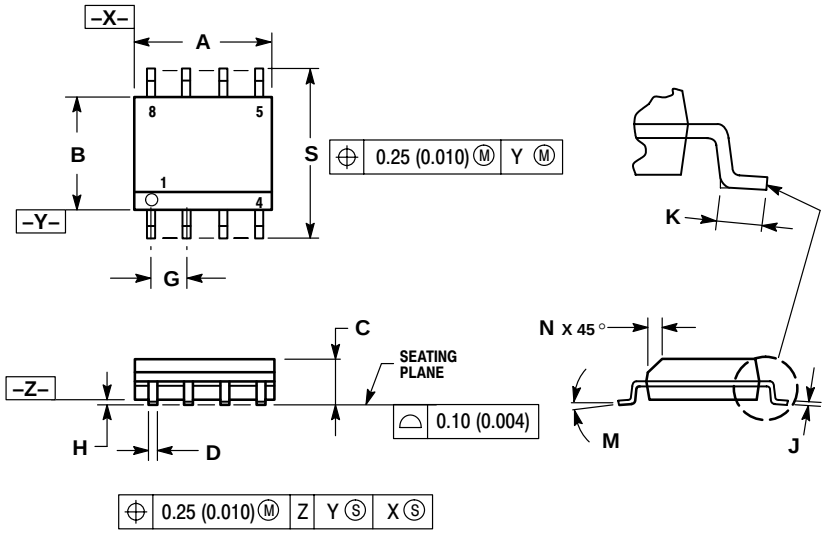
Resource Reference of Application Notes

AN1404	–	ECLinPS Circuit Performance at Non–Standard V_{IH} Levels
AN1405	–	ECL Clock Distribution Techniques
AN1406	–	Designing with PECL (ECL at +5.0 V)
AN1504	–	Metastability and the ECLinPS Family
AN1568	–	Interfacing Between LVDS and ECL
AN1650	–	Using Wire–OR Ties in ECLinPS Designs
AN1672	–	The ECL Translator Guide
AND8001	–	Odd Number Counters Design
AND8002	–	Marking and Date Codes
AND8009	–	ECLinPS Plus Spice I/O Model Kit
AND8020	–	Termination of ECL Logic Devices

For an updated list of Application Notes, please see our website at http://onsemi.com.

PACKAGE DIMENSIONS

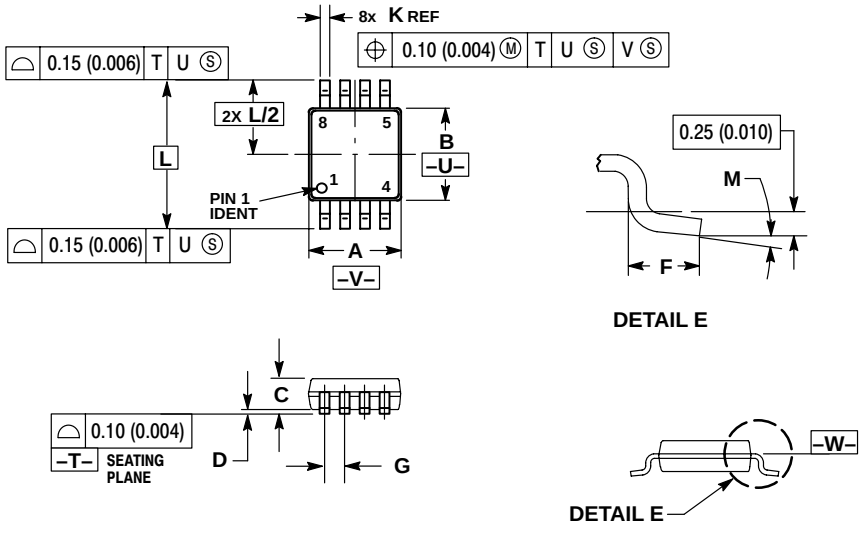
SO–8
D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751–07
ISSUE AA



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751–01 THRU 751–06 ARE OBSOLETE. NEW STANDAARD IS 751–07

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

TSSOP–8
DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948R–02
ISSUE A



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	2.90	3.10	0.114	0.122
B	2.90	3.10	0.114	0.122
C	0.80	1.10	0.031	0.043
D	0.05	0.15	0.002	0.006
F	0.40	0.70	0.016	0.028
G	0.65 BSC		0.026 BSC	
K	0.25	0.40	0.010	0.016
L	4.90 BSC		0.193 BSC	
M	0 °	6 °	0 °	6 °

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